



Product Change Notification / MFOL-24ZYG1261

Date:

25-Aug-2023

Product Category:

SAS Silicon & SW

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6534 Initial Notice: Qualification of HANK as an additional assembly site and WINS as an additional bumping site for selected PM82xxB1 device family available in 884L BBGA (25x25x2.78mm) package.

Affected CPNs:

[MFOL-24ZYG1261_Affected_CPN_08252023.pdf](#)
[MFOL-24ZYG1261_Affected_CPN_08252023.csv](#)

Notification Text:

PCN Status:Initial Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section.
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of HANK as an additional assembly site and WINS as an additional bumping site for selected PM82xxB1 device family available in 884L BBGA (25x25x2.78mm) package.

Pre and Post Change Summary:

	Pre Change	Post Change
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Affected Catalog Part Numbers (CPN)

PM8252B1-F3EIS1

PM8253B1-F3EIS1

PM8254B1-F3EIS1

PM8255B1-F3EIS1

PM8262B1-F3EIS1

PM8263B1-F3EIS1

PM8264B1-F3EIS1

PM8265B1-F3EIS1